

Multilayer Ceramic Chip Capacitors

C1608X5R0G226M080AA



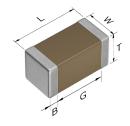






TDK item description C1608X5R0G226MT*****

Applications	Commercial Grade	
Feature	General General (Up to 75V)	
Series	C1608 [EIA 0603]	
Status	Production	



Size		
Length(L)	1.60mm ±0.20mm	
Width(W)	0.80mm ±0.20mm	
Thickness(T)	0.80mm ±0.20mm	
Terminal Width(B)	0.20mm Min.	
Terminal Spacing(G)	0.30mm Min.	
Recommended Land Pattern (PA)	0.70mm to 1.00mm(Flow Soldering)	
Neconimended Land Fattern (FA)	0.60mm to 0.80mm(Reflow Soldering)	
Recommended Land Pattern (PB)	0.80mm to 1.00mm(Flow Soldering)	
	0.60mm to 0.80mm(Reflow Soldering)	
Recommended Land Pattern (PC)	0.60mm to 0.80mm(Flow Soldering)	
Recommended Edital accent (1 C)	0.60mm to 0.80mm(Reflow Soldering)	

Electrical Characteristics		
Capacitance	22μF ±20%	
Rated Voltage	4VDC	
Temperature Characteristic	X5R(±15%)	
Dissipation Factor (Max.)	10%	
Insulation Resistance (Min.)	4ΜΩ	

Other		
Coldoring Mothod	Wave (Flow)	
Soldering Method	Reflow	
AEC-Q200	No	
Packing	Punched (Paper)Taping [180mm Reel]	
Package Quantity	4000pcs	

[!] Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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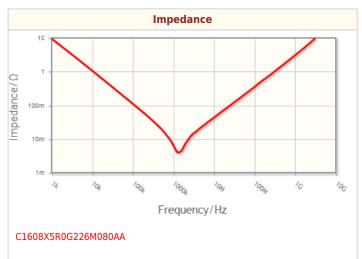


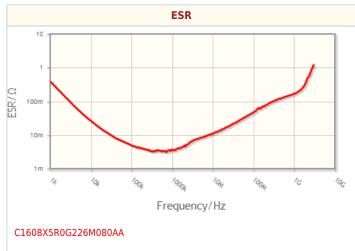


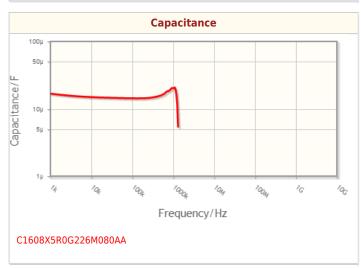


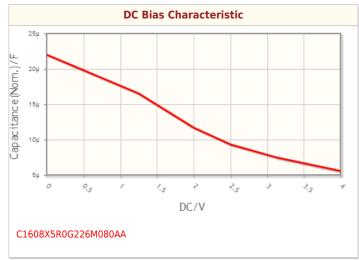


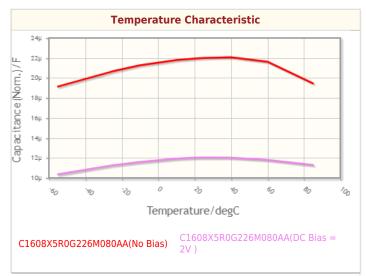
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

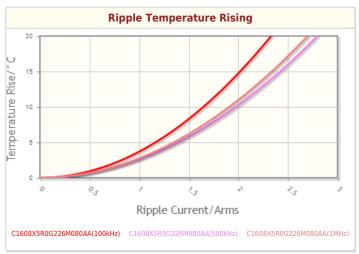












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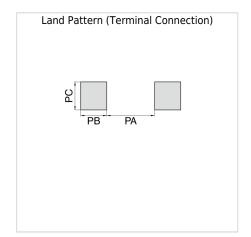








Associated Images



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